

DuraFlash

BGAE540 | eMMC | 153-ball/100-ball

SMART's DuraFlash BGAE540 eMMC is a soldered-down Flash storage solution that combines NAND Flash memory, an embedded MMC (MultiMediaCard) Controller, and advanced firmware in a small BGA (Ball Grid Array) package that provides stable, yet cost effective high-density embedded storage. The BGAE540 eMMC is designed to meet the rigid requirements of the industrial, medical and networking markets.

SMART's BGAE540 eMMC is compliant to eMMC v5.1 specifications and is available in the standard JEDEC 0.5mm pitch, 153-ball BGA package, as well 1.0mm pitch, 100-ball BGA package. The 100-ball package offers larger ball pitch and ball diameter enabling lower cost PCB designs and simplifies PCB routing with wider metal traces.

Features & Benefits

- Compliant to JEDEC v5.1 Standard
- BGAE540 SE: Base eMMC, TLC NAND with Capacities from 16GB to 128GB
- BGAE540 UE: Pre-configured to pSLC Enhanced Storage Media Mode with User Capacities from 5GB to 40GB
- Industrial Temp (-40°C to +85°C)

Product Family Overview

Capacity	Sequential Performance
BGAE540 SE eMMC 153-ball/100-ball	
16GB to 128GB	Up to 320MB/s Read; Up to 45MB/s Write
BGAE540 UE eMMC 153-ball/100-ball	
5GB to 40GB	Up to 320MB/s Read; Up to 215MB/s Write



Applications

- Factory Automation
- IIoT
- Medical Devices
- Networking Appliances
- POS Terminals
- RFID Scanners
- Single-Board Computers
- Telecom Infrastructure

Specifications (BGAE540 SE)

	BGAE540 SE 153-ball	BGAE540 SE 100-ball	
NAND Type	TLC		
Performance			
Host Interface Rate (maximum)	eMMC v5.1 (HS400)		
Capacities	16GB to 128GB		
Sequential Read (maximum)	Up to 320 MB/s		
Sequential Write (maximum)	Up to 45 MB/s		
Random Read (maximum)	Up to 9.3	Up to 9.3K IOPS	
Random Write (maximum)	Up to 2.1K IOPS		
Reliability			
	128GB: 40 TBW		
Endurance	64GB: 20 TBW		
(JEDEC Enterprise Workload)	32GB: 10 TBW		
	16GB: 25 TBW		
Data Retention	10 years		
Error Correction	LDPC		
Power			
Input Voltage	3.3V ± 10%		
Environmental			
On anothing Observe	1500 g half-sine, 0.5 msec, 1 shock along each axis,		
Operating Shock	X, Y, Z in ea	X, Y, Z in each direction	
Operating Vibration	20G 80-2000Hz, 1.52mm 20-80Hz, 3 axis		
Operating Temperature	Industrial: -40°C to +85°C		
Storage Temperature	-40°C to +85°C		
Physical			
Length	11.5 mm	14 mm	
Width	13 mm	18 mm	
Height	1.0 mm	2.45 mm	

Ordering Information (BGAE540 SE)

Part Number	Density	
BGAE540 SE eMMC 153-ball Industrial Operating Temperature (-40°C to +85°C)		
SP9MDGP3AMI01	128GB	
SP9MCGP3AMI01	64GB	
SP9MBGP3AMI01	32GB	
SP9MAGP3AMI01	16GB	
BGAE540 SE eMMC 100-ball Industrial Operating Temperature (-40°C to +85°C)		
SP9QDGP3AMI01	128GB	
SP9QCGP3AMI01	64GB	
SP9QBGP3AMI01	32GB	
SP9QAGP3AMI01	16GB	

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Specifications (BGAE540 UE)

	BGAE540 UE 153-ball	BGAE540 UE 100-ball	
NAND Type	pSLC		
Performance			
Host Interface Rate (maximum)	eMMC v5.1 (HS400)		
Capacities	5GB to 40GB		
Sequential Read (maximum)	Up to 320 MB/s		
Sequential Write (maximum)	Up to 215 MB/s		
Random Read (maximum)	Up to 9.3K IOPS		
Random Write (maximum)	Up to 2.1K IOPS		
Reliability			
	40GB: 88 TBW		
Endurance	20GB: 44 TBW		
(JEDEC Enterprise Workload)	10GB: 22 TBW		
	5GB: 11 TBW		
Data Retention	10 years		
Error Correction	LDPC		
Power			
Input Voltage	3.3V ± 10%		
Environmental			
Operating Sheek	1500 g half-sine, 0.5 msec, 1 shock along each axis,		
Operating Shock	X, Y, Z in each direction		
Operating Vibration	20G 80-2000Hz, 1.52mm 20-80Hz, 3 axis		
Operating Temperature	Industrial: -40°C to +85°C		
Storage Temperature	-40°C to +85°C		
Physical			
Length	11.5 mm	14 mm	
Width	13 mm	18 mm	
Height	1.0 mm	2.45 mm	

Ordering Information (BGAE540 UE)

Part Number	Density	
BGAE540 UE eMMC 153-ball Industrial Operating Temperature (-40°C to +85°C)		
SP9MDGP3AMI11	40GB	
SP9MCGP3AMI11	20GB	
SP9MBGP3AMI11	10GB	
SP9MAGP3AMI11	5GB	
BGAE540 UE eMMC 100-ball Industrial Operating Temperature (-40°C to +85°C)		
SP9QDGP3AMI11	40GB	
SP9QCGP3AMI11	20GB	
SP9QBGP3AMI11	10GB	
SP9QAGP3AMI11	5GB	

SMART Modular Technologies

For more information, please visit: www.smartm.com

*Product images are for promotional purposes only. Labels may not be representative of the actual product.

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